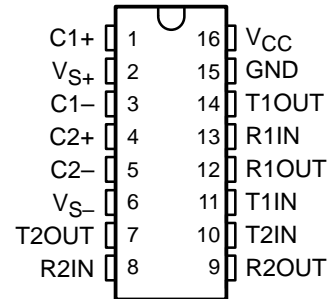


# MAX232, MAX232I DUAL EIA-232 DRIVERS/RECEIVERS

SLLS0471 – FEBRUARY 1989 – REVISED OCTOBER 2002

- Meet or Exceed TIA/EIA-232-F and ITU Recommendation V.28
- Operate With Single 5-V Power Supply
- Operate Up to 120 kbit/s
- Two Drivers and Two Receivers
- $\pm 30$ -V Input Levels
- Low Supply Current . . . 8 mA Typical
- Designed to be Interchangeable With Maxim MAX232
- ESD Protection Exceeds JESD 22 – 2000-V Human-Body Model (A114-A)
- Applications
  - TIA/EIA-232-F
  - Battery-Powered Systems
  - Terminals
  - Modems
  - Computers

MAX232 . . . D, DW, N, OR NS PACKAGE  
MAX232I . . . D, DW, OR N PACKAGE  
(TOP VIEW)



## description/ordering information

The MAX232 is a dual driver/receiver that includes a capacitive voltage generator to supply EIA-232 voltage levels from a single 5-V supply. Each receiver converts EIA-232 inputs to 5-V TTL/CMOS levels. These receivers have a typical threshold of 1.3 V and a typical hysteresis of 0.5 V, and can accept  $\pm 30$ -V inputs. Each driver converts TTL/CMOS input levels into EIA-232 levels. The driver, receiver, and voltage-generator functions are available as cells in the Texas Instruments LinASIC™ library.

## ORDERING INFORMATION

T <sub>A</sub>	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	PDIP (N)	Tube	MAX232N	MAX232N
	SOIC (D)	Tube	MAX232D	MAX232
		Tape and reel	MAX232DR	
	SOIC (DW)	Tube	MAX232DW	MAX232
		Tape and reel	MAX232DWR	
–40°C to 85°C	SOP (NS)	Tape and reel	MAX232NSR	MAX232
	PDIP (N)	Tube	MAX232IN	MAX232IN
	SOIC (D)	Tube	MAX232ID	MAX232I
		Tape and reel	MAX232IDR	
	SOIC (DW)	Tube	MAX232IDW	MAX232I
		Tape and reel	MAX232IDWR	

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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**MAX232, MAX232I**  
**DUAL EIA-232 DRIVERS/RECEIVERS**

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**Function Tables**

**EACH DRIVER**

INPUT TIN	OUTPUT TOUT
L	H
H	L

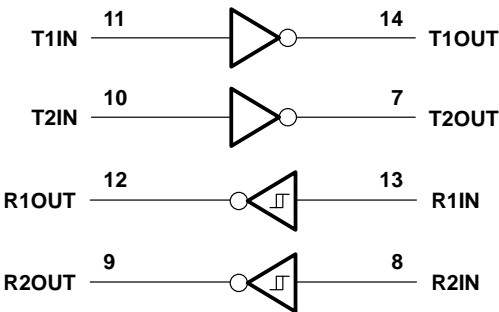
H = high level, L = low level

**EACH RECEIVER**

INPUT RIN	OUTPUT ROUT
L	H
H	L

H = high level, L = low level

**logic diagram (positive logic)**



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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Input supply voltage range, $V_{CC}$ (see Note 1)	–0.3 V to 6 V
Positive output supply voltage range, $V_{S+}$	$V_{CC} - 0.3$ V to 15 V
Negative output supply voltage range, $V_{S-}$	–0.3 V to –15 V
Input voltage range, $V_I$ : Driver	–0.3 V to $V_{CC} + 0.3$ V
Receiver	$\pm 30$ V
Output voltage range, $V_O$ : T1OUT, T2OUT	$V_{S-} - 0.3$ V to $V_{S+} + 0.3$ V
R1OUT, R2OUT	–0.3 V to $V_{CC} + 0.3$ V
Short-circuit duration: T1OUT, T2OUT	Unlimited
Package thermal impedance, $\theta_{JA}$ (see Note 2): D package	73°C/W
DW package	57°C/W
N package	67°C/W
NS package	64°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, $T_{stg}$	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to network ground terminal.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

## recommended operating conditions

		MIN	NOM	MAX	UNIT
$V_{CC}$	Supply voltage	4.5	5	5.5	V
$V_{IH}$	High-level input voltage (T1IN, T2IN)	2			V
$V_{IL}$	Low-level input voltage (T1IN, T2IN)			0.8	V
R1IN, R2IN	Receiver input voltage			$\pm 30$	V
$T_A$	Operating free-air temperature	MAX232	0	70	°C
		MAX232I	–40	85	

## electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 3 and Figure 4)

PARAMETER	TEST CONDITIONS	MIN	TYP <sup>‡</sup>	MAX	UNIT
$I_{CC}$ Supply current	$V_{CC} = 5.5$ V, All outputs open, $T_A = 25^\circ\text{C}$		8	10	mA

<sup>‡</sup> All typical values are at  $V_{CC} = 5$  V and  $T_A = 25^\circ\text{C}$ .

NOTE 3: Test conditions are C1–C4 = 1  $\mu\text{F}$  at  $V_{CC} = 5$  V  $\pm 0.5$  V.



# MAX232, MAX232I

## DUAL EIA-232 DRIVERS/RECEIVERS

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### DRIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature range (see Note 3)

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
V <sub>OH</sub>	High-level output voltage	T1OUT, T2OUT R <sub>L</sub> = 3 kΩ to GND	5	7		V
V <sub>OL</sub>	Low-level output voltage‡	T1OUT, T2OUT R <sub>L</sub> = 3 kΩ to GND		–7	–5	V
r <sub>o</sub>	Output resistance	T1OUT, T2OUT V <sub>S+</sub> = V <sub>S–</sub> = 0, V <sub>O</sub> = ±2 V	300			Ω
I <sub>OS</sub> §	Short-circuit output current	T1OUT, T2OUT V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 0		±10		mA
I <sub>IS</sub>	Short-circuit input current	T1IN, T2IN V <sub>I</sub> = 0			200	μA

† All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

‡ The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for logic voltage levels only.

§ Not more than one output should be shorted at a time.

NOTE 3: Test conditions are C1–C4 = 1 μF at V<sub>CC</sub> = 5 V ± 0.5 V.

switching characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C (see Note 3)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
SR	Driver slew rate	R <sub>L</sub> = 3 kΩ to 7 kΩ, See Figure 2			30	V/μs
SR(t)	Driver transition region slew rate	See Figure 3		3		V/μs
	Data rate	One TOUT switching		120		kbit/s

NOTE 3: Test conditions are C1–C4 = 1 μF at V<sub>CC</sub> = 5 V ± 0.5 V.

### RECEIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature range (see Note 3)

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
V <sub>OH</sub>	High-level output voltage	R1OUT, R2OUT I <sub>OH</sub> = –1 mA	3.5			V
V <sub>OL</sub>	Low-level output voltage‡	R1OUT, R2OUT I <sub>OL</sub> = 3.2 mA			0.4	V
V <sub>IT+</sub>	Receiver positive-going input threshold voltage	R1IN, R2IN V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C		1.7	2.4	V
V <sub>IT–</sub>	Receiver negative-going input threshold voltage	R1IN, R2IN V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C	0.8	1.2		V
V <sub>hys</sub>	Input hysteresis voltage	R1IN, R2IN V <sub>CC</sub> = 5 V	0.2	0.5	1	V
r <sub>i</sub>	Receiver input resistance	R1IN, R2IN V <sub>CC</sub> = 5, T <sub>A</sub> = 25°C	3	5	7	kΩ

† All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

‡ The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for logic voltage levels only.

NOTE 3: Test conditions are C1–C4 = 1 μF at V<sub>CC</sub> = 5 V ± 0.5 V.

switching characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C (see Note 3 and Figure 1)

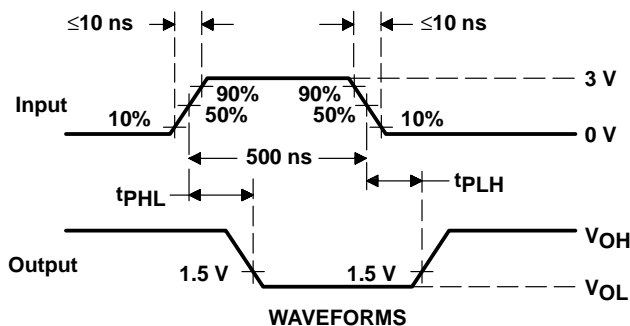
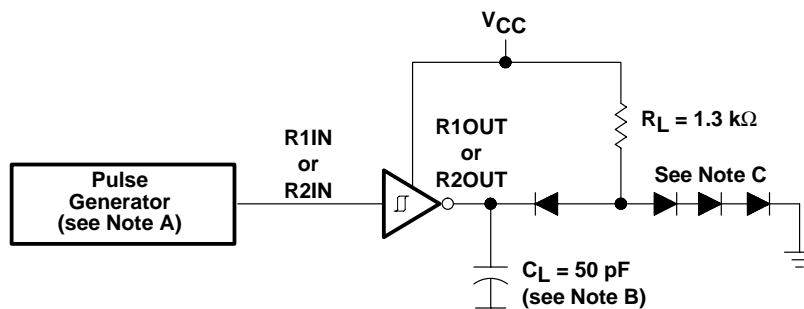
PARAMETER		TYP	UNIT
t <sub>PLH(R)</sub>	Receiver propagation delay time, low- to high-level output	500	ns
t <sub>PHL(R)</sub>	Receiver propagation delay time, high- to low-level output	500	ns

NOTE 3: Test conditions are C1–C4 = 1 μF at V<sub>CC</sub> = 5 V ± 0.5 V.



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## PARAMETER MEASUREMENT INFORMATION



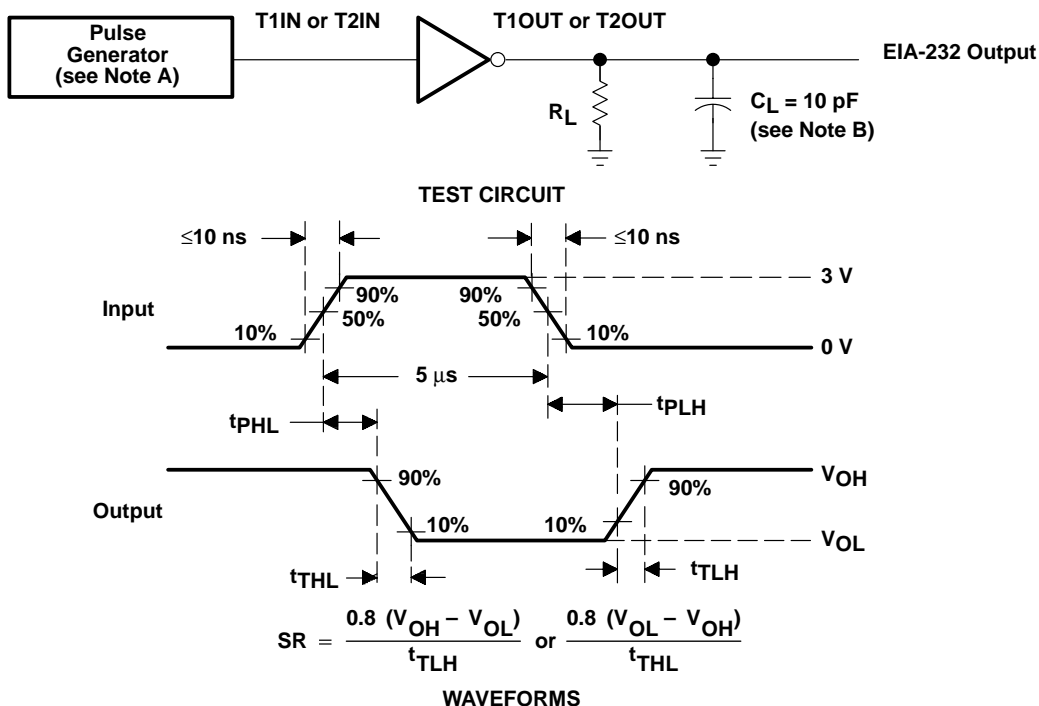
- NOTES: A. The pulse generator has the following characteristics:  $Z_O = 50 \Omega$ , duty cycle  $\leq 50\%$ .  
B.  $C_L$  includes probe and jig capacitance.  
C. All diodes are 1N3064 or equivalent.

Figure 1. Receiver Test Circuit and Waveforms for  $t_{PHL}$  and  $t_{PLH}$  Measurements

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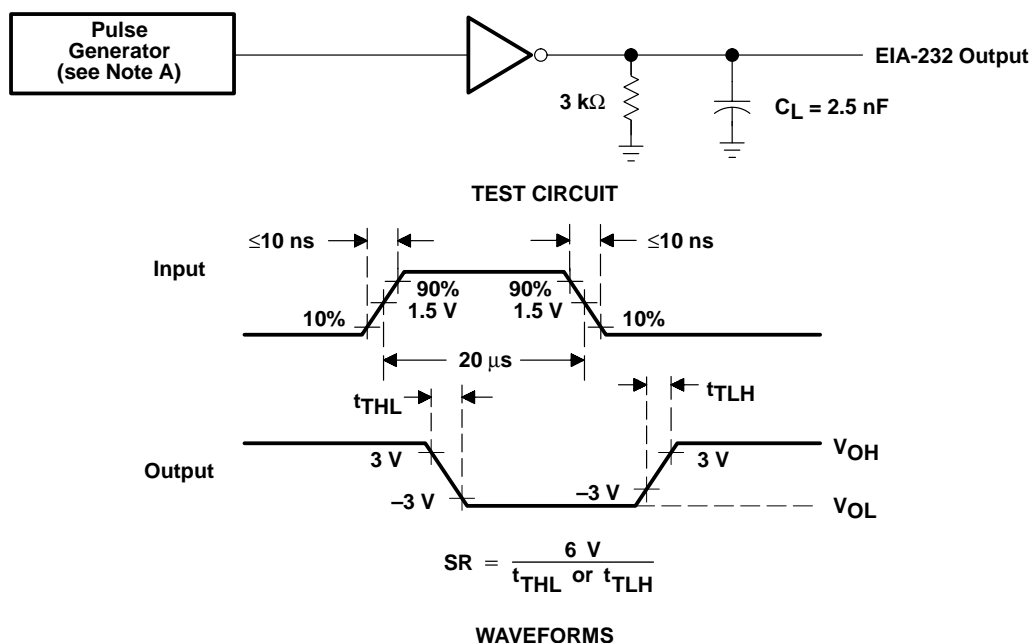
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## PARAMETER MEASUREMENT INFORMATION



NOTES: A. The pulse generator has the following characteristics:  $Z_O = 50 \Omega$ , duty cycle  $\leq 50\%$ .  
B.  $C_L$  includes probe and jig capacitance.

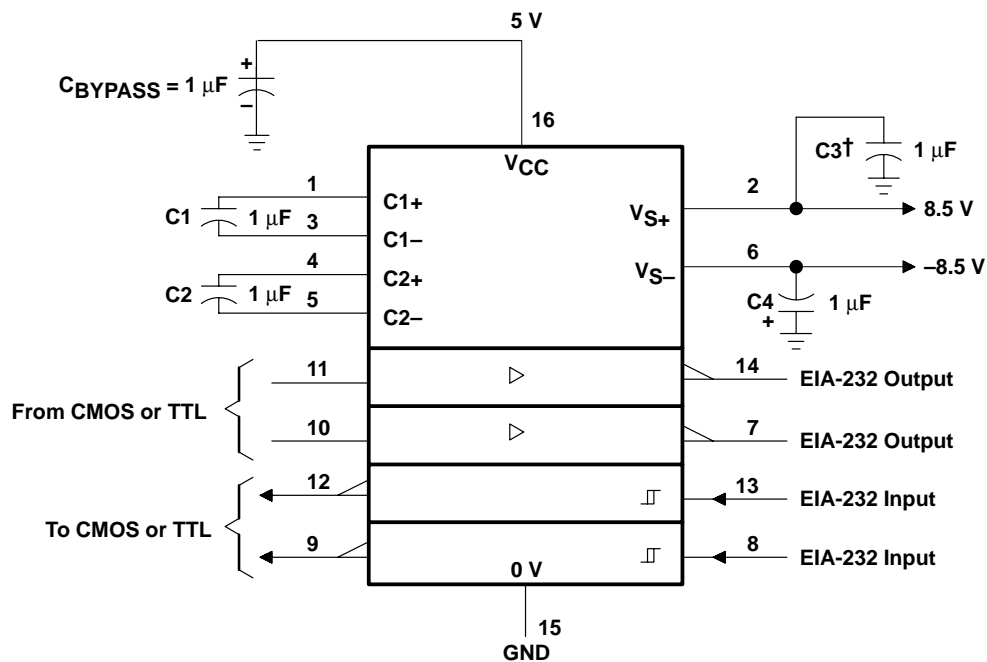
Figure 2. Driver Test Circuit and Waveforms for  $t_{PHL}$  and  $t_{PLH}$  Measurements (5- $\mu\text{s}$  Input)



NOTE A: The pulse generator has the following characteristics:  $Z_O = 50 \Omega$ , duty cycle  $\leq 50\%$ .

Figure 3. Test Circuit and Waveforms for  $t_{THL}$  and  $t_{TLH}$  Measurements (20- $\mu\text{s}$  Input)

## APPLICATION INFORMATION



†  $C3$  can be connected to  $V_{CC}$  or GND.

Figure 4. Typical Operating Circuit

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